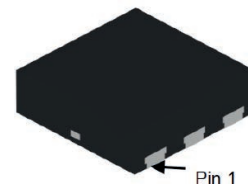


### Features

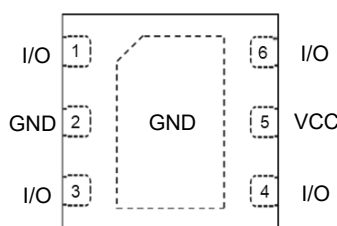
- Ultra low capacitance: 0.6pF typical (I/O to I/O)
- Ultra low leakage: nA level
- Low clamping voltage
- Up to 4 lines and one power line protects
- Complies with following standards:
  - IEC 61000-4-2 (ESD) immunity test
  - Air discharge:  $\pm 30\text{kV}$
  - Contact discharge:  $\pm 30\text{kV}$
  - IEC 61000-4-5 (Lightning) 12A (8/20 $\mu\text{s}$ )
- RoHS compliant



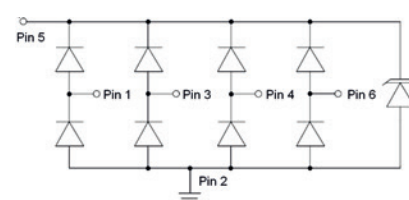
DFN2020-6

### Applications

- USB 2.0 power and data line
- Monitors and flat panel displays
- Set-top box and digital TV
- Digital visual interface (DVI)
- Notebook computers
- SIM ports
- 10/100 ethernet



Circuit and Pin Schematic



Schematic Diagram

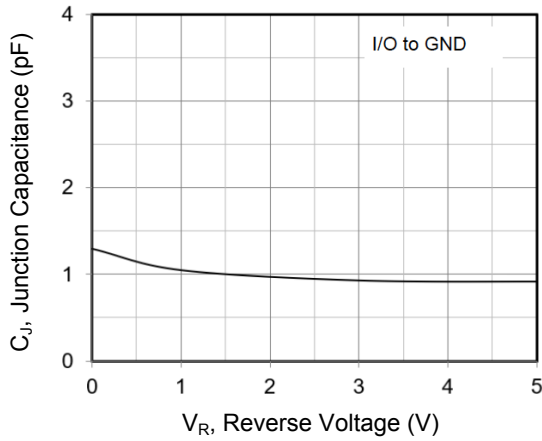
### Absolute Maximum Ratings $(T_A=25^\circ\text{C}$ unless otherwise spec)

Parameter	Symbol	Value	Unit
Peak Pulse Power (8/20 $\mu\text{s}$ ), $V_{CC}$ Pin to Ground	P <sub>PK</sub>	450	W
Peak Pulse Power (8/20 $\mu\text{s}$ ), Any I/O Pin to Ground		200	
Peak Pulse Current (8/20 $\mu\text{s}$ ), $V_{CC}$ Pin to Ground	I <sub>PP</sub>	25	A
Peak Pulse Current (8/20 $\mu\text{s}$ ), any I/O Pin to Ground		12	
ESD per IEC 61000-4-2 (Air)	V <sub>ESD</sub>	$\pm 30$	kV
ESD per IEC 61000-4-2 (Contact)		$\pm 30$	
Operating Temperature Range	T <sub>J</sub>	-55 to +125	$^\circ\text{C}$
Storage Temperature Range	T <sub>stg</sub>	-55 to +150	$^\circ\text{C}$

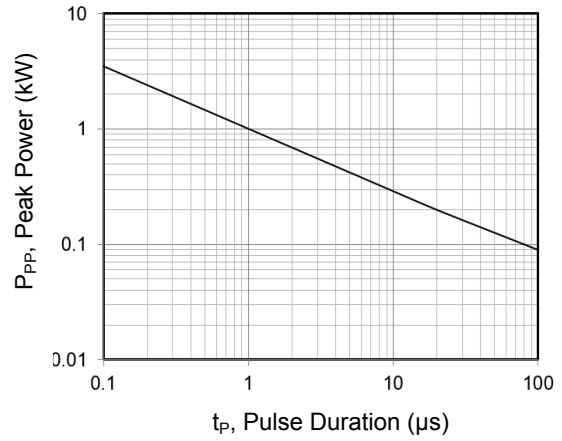
### Electrical Characteristics $(T_A=25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Reverse Working Voltage	V <sub>RWM</sub>	Any I/O pin to ground	-	-	5	V
Breakdown Voltage	V <sub>BR</sub>	I <sub>T</sub> =1mA, any I/O pin to ground	6	-	-	V
Reverse Leakage Current	I <sub>R</sub>	V <sub>RWM</sub> =5V, any I/O pin to ground	-	-	0.5	$\mu\text{A}$
Clamping Voltage	V <sub>C</sub>	I <sub>PP</sub> =25A (8 x 20 $\mu\text{s}$ pulse), $V_{CC}$ pin to ground	-	15	18	V
		I <sub>PP</sub> =12A (8 x 20 $\mu\text{s}$ pulse), any I/O pin to ground	-	12	16.7	V
Junction Capacitance	C <sub>J</sub>	V <sub>R</sub> =0V, f=1MHz, between I/O pins	-	0.6	-	pF
		V <sub>R</sub> =0V, f=1MHz, any I/O pin to ground	-	1.5	-	pF

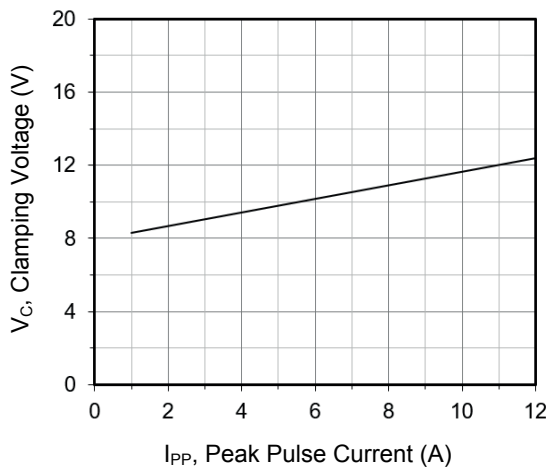
**Typical Performance Characteristic** ( $T_A=25^\circ\text{C}$  unless otherwise Specified)



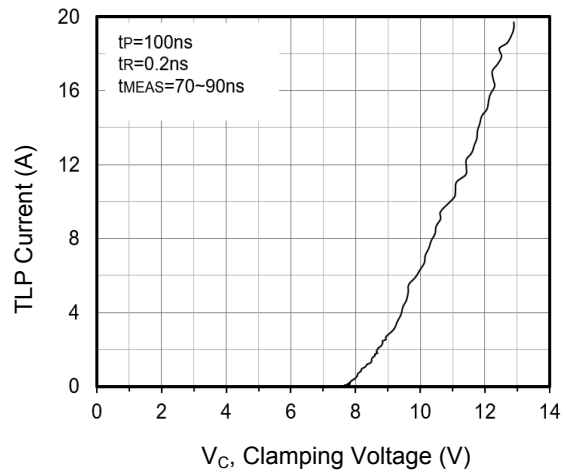
**Figure 1. Junction Capacitance vs. Reverse Voltage**



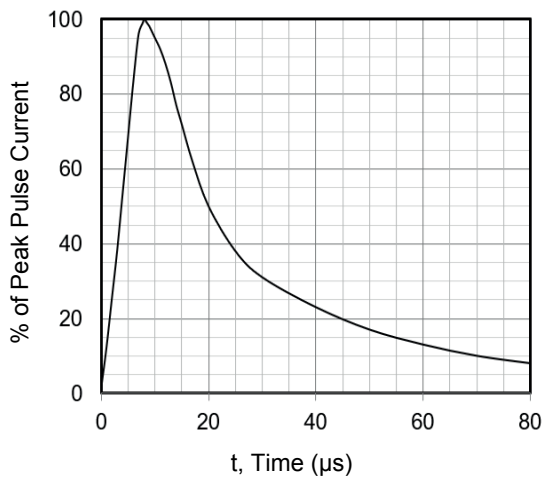
**Figure 2. Peak Pulse Power vs. Pulse Time**



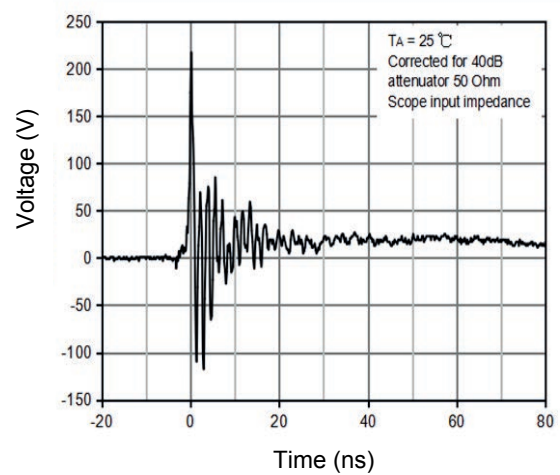
**Figure 3. Clamping Voltage vs. Peak Pulse Current**  
( $t_p=8/20\mu\text{s}$ )



**Figure 4. TLP Measurement**

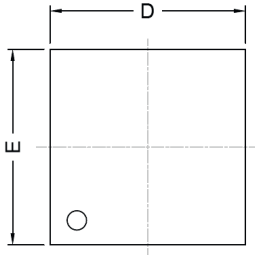


**Figure 5. 8 X 20 $\mu\text{s}$  Pulse Waveform**

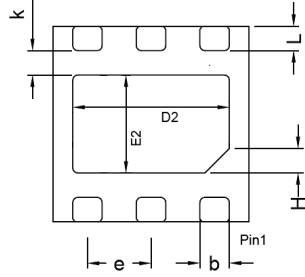


**Figure 6. ESD Clamping Voltage**  
**8 kV Contact per IEC61000-4-2**

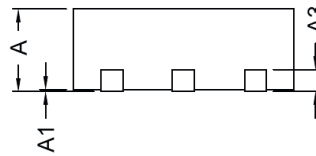
**Package Outline Dimensions (DFN2020-6)**



TOP VIEW



BOTTOM VIEW



SIDE VIEW

Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.50	0.60	0.020	0.024
A1	-	0.05	-	0.002
A3	0.20 REF		0.008 REF	
b	0.25	0.35	0.010	0.014
D	1.95	2.05	0.077	0.081
D2	1.50	1.70	0.059	0.067
E	1.95	2.05	0.077	0.081
E2	0.90	1.10	0.035	0.043
e	0.65 BSC		0.026 BSC	
L	0.20	0.30	0.008	0.012
k	0.20	0.35	0.008	1.378
H	0.18	0.25	0.007	0.984

**Order Information**

Device	Package	Marking	Carrier	Quantity
GSEPP5U006	DFN2020-6	534P	Tape & Reel	3,000pcs / Reel